

1.6x0.8mm SMD CHIP LED LAMP

#### **Features**

• Ideal for indication light on hand held products

• Long life and robust package

• Standard Package: 2,000pcs/ Reel

 $\bullet$  MSL (Moisture Sensitivity Level): 3

• RoHS compliant





# Package Schematics 0.25(0.01) 1.6(0.063) 0.15(0.006) 1.2(0.047) 0.4(0.016) 0.45(0.018)MAX .1(0.043) 0.3(0.012) 0.3(0.012) 2

POLARITY MARK

1. All dimensions are in millimeters (inches).

Notes:

2. Tolerance is  $\pm 0.1(0.004")$  unless otherwise noted.

3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		MDK (AlGaInP)	Unit	
Reverse Voltage	$V_{\mathrm{R}}$	5	V	
Forward Current	$I_{\mathrm{F}}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	$i_{\mathrm{FS}}$	185	mA	
Power Dissipation	$P_D$	75	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85		

Operating Characteristics ( $T_A$ =25°C)	MDK (AlGaInP)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$ m V_{F}$	1.95	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$ m V_{F}$	2.5	V
Reverse Current (Max.) $(V_R=5V)$	${ m I}_{ m R}$	10	uA
Wavelength of Peak Emission CIE127-2007*(Typ.) (I <sub>F</sub> =20mA)	λΡ	645*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) $(I_F=20\text{mA})$	λD	630*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$\triangle \lambda$	28	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	35	pF

Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} \text{Luminous Intensity} \\ \text{CIE127-2007*} \\ \text{(I_F=20mA)} \\ \text{mcd} \end{array}$		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
ZMDK53W-3	Red	AlGaInP	Water Clear	120 40*	228 79*	645*	120°

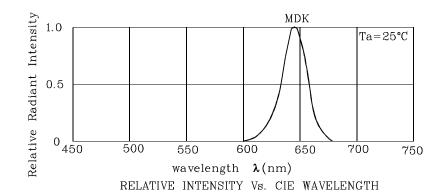
<sup>\*</sup>Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

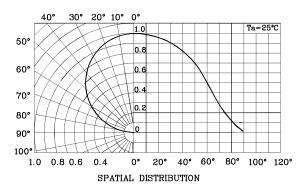
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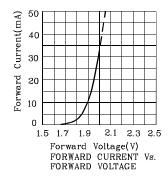


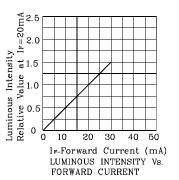


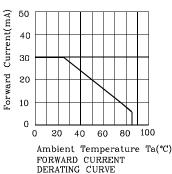


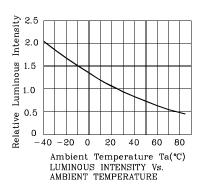


### **❖** MDK



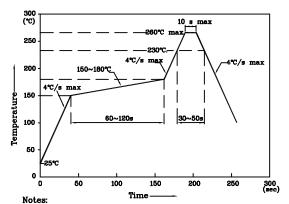






# LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

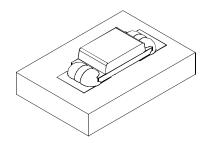


- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

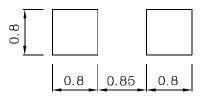




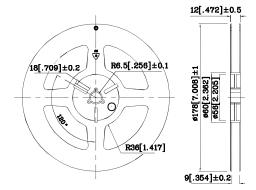
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



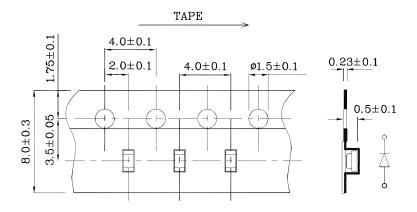
**♦** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



### **❖** Reel Dimension



### ❖ Tape Specification (Units:mm)



#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

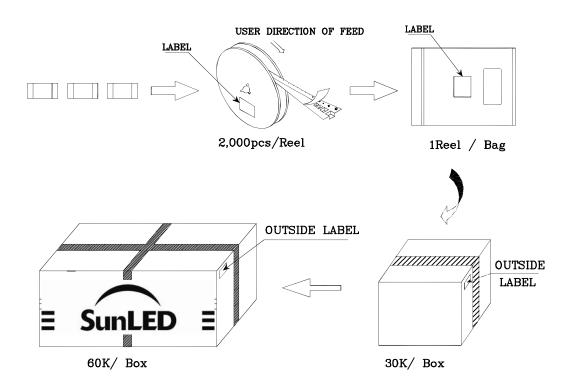
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

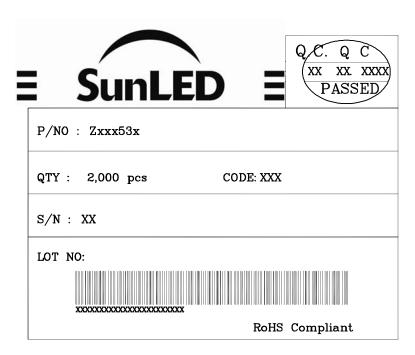
Note: Accuracy may depend on the sorting parameters.





### PACKING & LABEL SPECIFICATIONS





#### TERMS OF USE

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- 2. Contents within this document are subject to improvement and enhancement changes without notice.
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